

भारत सरकार
Government of India
इलेक्ट्रॉनिकी और सूचना प्रौद्योगिकी मंत्रालय
Ministry of Electronics & Information Technology
इलेक्ट्रॉनिक्स निकेतन, 6, सी जी ओ कॉम्प्लेक्स, नई दिल्ली-110003
Electronics Niketan, 6, C G O Complex, New Delhi-110003
Website: www.meity.gov.in

संख्या

No. 36(6)/2014-IPHW (Vol.V)

दिनांक

Date.....8th August, 2017

Shri E V Narasimha Reddy,

Vice Chairman and Managing Director

Telangana State Industrial Infrastructure Corporation Limited (TSIIC)

6th Floor, Parisrama Bhavan, Fateh Maidan Road, Basheerbagh,

Hyderabad-500004, Telangana

Subject: Electronics Manufacturing Clusters (EMC) Scheme-Final approval for Greenfield Electronics Manufacturing Cluster at Maheshwaram, Ranga Reddy District, Telangana

References:

- Final application submitted vide letter dated 5th February, 2014, subsequently revised and resubmitted on 11th August 2016 and documents/correspondences made thereafter by the Chief Promoter M/s Telangana State Industrial Infrastructure Corporation Limited (TSIIC)
- EMC Policy Gazette Notification no. 252 dated 22nd October 2012 [F.No.8(50)/2011 – IPHW]
- Guidelines for operationalization of EMC Scheme dated 15th April 2013 [F.No.8(50)/2011–IPHW]
- Guidelines for constitution of SPV dated 30th January 2014 [F.No. 8(131)/2012-IPHW]

Sir,

Reference is invited to final application submitted vide letter dated 5th February, 2014, subsequently revised and resubmitted on 11th August 2016 and correspondences made thereafter for seeking grant assistance under Electronics Manufacturing Cluster (EMC) Scheme from this Ministry for setting up of Greenfield Electronics Manufacturing Cluster at Maheshwaram, Ranga Reddy District, Telangana. The said application and documents submitted by you have been considered by the Ministry of Electronics and Information Technology (MeitY) and on the basis of the assurances and commitments made therein, I am directed to convey the approval of the competent authority for setting up of Greenfield Electronics Manufacturing Cluster over an area of acres at 310.70 acres at Maheshwaram, Ranga Reddy District, Telangana with an approved project cost of ₹ 436,97,36,575/- (₹ Four Hundred and Thirty Six Crore Ninety Seven Lakh Thirty Six Thousand Five Hundred Seventy Five only) [excluding land cost] providing Grant-in-aid of ₹ 138,60,50,000/- (₹ One Hundred and Thirty Eight Crore Sixty Lakh Fifty Thousand only)

2. The parameters of the project are mentioned hereunder. The area mentioned below is being notified as a Greenfield Electronic Manufacturing Cluster under the EMC Scheme of MeitY.

| # | Project Parameter(s) | Details |
|----|---|--|
| 1. | Name of the Applicant | M/s Telangana State Industrial Infrastructure Corporation Ltd. (TSIIC)- Chief Promoter |
| 2. | Location details of the Greenfield EMC | Maheshwaram, Ranga Reddy District, Telangana (Survey number 306/1 provided by M/s TSIIC as per Annexure-C) |
| 3. | Area of EMC | 310.70 acres <ul style="list-style-type: none"> Processing area: 251.00 acres (90.55%) Non – Processing area: 26.21 acres (9.45%) One water body (on east side): 33.50 acres |
| 4. | Sector identified for the EMC | LED components, consumables and accessories etc. |
| 5. | Timelines for formation of SPV | SPV has been formed and will be restructured within twenty four (24) months from the date of final approval in compliance to SPV Guidelines issued by MeitY dated 30 th January, 2014 (As per undertaking submitted by M/s TSIIC vide its letter dated 7 th October 2016) |
| 6. | Project Timeline | 36 months from the date of final approval |

TERMS AND CONDITIONS

3. This approval and Grant-in-aid is subject to compliance by the Telangana State Industrial Infrastructure Corporation Ltd(TSIIC) or the SPV (*as the case be*) to the EMC Scheme and Guidelines and other instructions, orders etc. issued by the Government of India from time to time, and the terms and conditions stipulated hereafter. Capitalized terms used in this letter shall have the meaning ascribed to such terms in **Annexure A** of this letter.

4. The Grant-in-aid has been approved on basis of the eligible activities, break-up of project cost and funding pattern approved by the competent authority under the Electronics Manufacturing Clusters Scheme which is provided in the table hereunder. The TSIIC or the SPV (*as the case be*) undertakes to comply with the eligible activities, break-up of project cost and funding pattern as provided herein.

| # | Project Component | Plot Area | Built up Area | Unit | Quantity | Amount (In ₹) |
|-----------------------------------|--|-----------|---------------|-----------|--------------|----------------------|
| Processing Area Activities | | | | | | 278,06,38,120 |
| A | Basic Development | | | | | |
| A1 | Boundary Wall | NA | NA | RM | 2,800 | 4,39,89,191 |
| A2 | Site Development/ Site Grading | NA | NA | Sqm | 12,57,403 | 19,36,44,880 |
| A3 | <i>Internal Roads with Service Reserve</i> | <i>NA</i> | <i>NA</i> | <i>RM</i> | <i>8,925</i> | <i>54,66,55,282</i> |
| A3.1 | 45 M wide RoW roads | NA | NA | RM | 2,112 | 12,93,59,771 |
| A3.2 | 30 M wide RoW roads | NA | NA | RM | 444 | 2,71,94,952 |
| A3.3 | 24 M Wide RoW Roads | NA | NA | RM | 1,526 | 9,34,67,334 |
| A3.4 | 18 M Wide RoW Roads | NA | NA | RM | 1,694 | 10,37,57,316 |
| A3.5 | 12 M Wide RoW Roads | NA | NA | RM | 923 | 5,65,33,650 |
| A3.6 | 7.5 m Wide RoW Roads | NA | NA | RM | 2,226 | 13,63,42,258 |
| A4 | Green Belt Development/ Avenue Plantation | NA | NA | Sqm | 2,47,676 | 1,62,50,000 |
| A5 | Storm Water Drainage system | NA | NA | Sqm | 12,57,403 | 24,50,08,409 |
| Sub-Total (A) | | | | | | 104,55,47,761 |
| B | Essential Services | | | | | |
| B1 | Water Supply & Distribution System | NA | NA | Sqm | 1257403 | 43,19,00,000 |
| B2 | Wastewater Collection, Treatment and Disposal | NA | NA | Sqm | 1257403 | 9,49,00,000 |
| B3 | Power Supply and Distribution | NA | NA | Sqm | 1257403 | 28,80,00,000 |
| B4 | Power back up - DG sets - 2 MVA each | NA | NA | 2 MVA | 4 | 8,00,00,000 |
| B5 | <i>Solid waste Management (including e-waste, civil & equipment costs)</i> | <i>NA</i> | <i>NA</i> | | - | <i>2,00,98,100</i> |
| B5.1 | Sweeping Machine - Ride on Type | NA | NA | | 2 | 53,00,000 |
| B5.2 | Truck mounted road sweeping machine | NA | NA | | 3 | 1,35,00,000 |
| B5.3 | Sintex make dust bins -50 litres | NA | NA | | 25 | 57,500 |
| B5.4 | Sintex make dust bins - 240 lites | NA | NA | | 20 | 1,10,000 |
| B5.5 | Sintex make dust bins - 1100 litres | NA | NA | | 20 | 11,30,600 |
| B6 | Logistics & warehouse building +MEP+ External development (G) | 14165 | 21460 | Sqm | NA | 27,38,37,503 |
| Sub-Total (B) | | | | | | 118,87,35,603 |



| # | Project Component | Plot Area | Built up Area | Unit | Quantity | Amount (In ₹) |
|----------|---|-----------|---------------|------|----------|---------------------|
| C | Support Services | | | | | |
| C1 | Incubation, Testing & Calibration, Training (G+1) | 21004 | 9536 | Sqm | NA | 26,83,19,411 |
| C1.1 | MEP | | | | | 5,78,40,470 |
| C1.2 | Other items (External development viz: Road, Electricity, Water etc.) | | | | | 5,50,94,875 |
| C2 | Facilities for banking/ ATM services (G) | | 400 | Sqm | NA | 71,00,000 |
| C3 | Telecom/ IT Infrastructure & Video Conferencing (Fibre Optics Technology) | | | Sqm | 1257403 | 2,00,00,000 |
| | Sub-Total (C) | | | | | 40,83,54,756 |
| D | Manufacturing Support Services | | | | | |
| D1 | Manufacturing Support Service Equipment (Annexure-D) | | | | | 13,80,00,000 |
| | Sub-Total (D) | | | | | 13,80,00,000 |
| | Non Processing Area Activities | | | | | 76,72,31,749 |
| E | Welfare Services | | | | | |
| E1 | Recreational facilities including, club house (G+1) | 25860 | 1330 | Sqm | NA | 3,05,90,000 |
| E2 | Local Shopping centre, canteen, restaurants (G+1) | | 2875 | Sqm | NA | 5,75,00,000 |
| E3 | Hospital/ health crèche (G+1) | | 2405 | Sqm | NA | 5,29,10,000 |
| E4 | Education facilities & Creche (G+1) | | 1255 | Sqm | NA | 2,76,10,000 |
| E5 | Employee Hostel & Mess(G+4) | | 17250 | Sqm | NA | 34,50,00,000 |
| | Sub-Total (E) | | | | | 51,36,10,000 |
| F | Others | | | | | |
| F1 | Entrance Plaza (G) | NA | NA | Sqm | 280 | 56,00,000 |
| F2 | Administration Building + MEP (G+2) | 9308.1 | 4830 | Sqm | NA | 24,80,21,749 |
| F3 | Green Area | - | - | - | - | - |
| | Sub-Total (F) | | | | | 25,36,21,749 |

| # | Project Component | Plot Area | Built up Area | Unit | Quantity | Amount (In ₹) |
|----------|---|-----------|---------------|------|--------------------------------------|----------------------|
| G | Approach Road | | | | | |
| G1 | Approach Road 1: From Maheshwaram village Mansanpally X Road | NA | NA | RM | 5700 | 45,15,66,706 |
| G2 | Approach Road 2: Srisailem highway - Maheshwaram bye pass to EMC boundary | NA | NA | RM | 3000 | 27,67,00,000 |
| G3 | Approach Road 3: Peripheral road - south of EMC site connecting villages to external road | NA | NA | RM | 1000 | 4,44,00,000 |
| | | | | | Sub-Total (G) | 77,26,66,706 |
| H | Administrative Expenses | | | | | 4,92,00,000 |
| | | | | | Sub-Total (H) | 4,92,00,000 |
| | | | | | Grand Total (A+B+C+D+E+F+G+H) | 436,97,36,575 |

5. The details of the project cost and grant-in-aid for the Project approved by the Competent Authority under the Electronics Manufacturing Clusters Scheme are as provided in table hereunder. The Chief Promoter or the SPV (*as the case be*) undertakes to comply with the project cost as provided herein.

(In ₹)

| # | Parameter | Area (in acres) | Project Cost | Grant – in – aid (from Gol) |
|---|-------------------------|-----------------|----------------------|-----------------------------|
| 1 | Processing area | 251.00 | 278,06,38,120 | 108,07,58,415 |
| 2 | Non processing area | 26.21 | 76,72,31,749 | 14,67,72,010 |
| 3 | Approach Road | | 77,26,66,706 | 11,69,38,075 |
| 4 | Administrative expenses | | 4,92,00,000 | 4,15,81,500 |
| | Total | 277.21* | 436,97,36,575 | 138,60,50,000 |

* In addition to 277.21 acres, one water body of 33.59 acres also falls within the EMC area. Therefore, the total area of the said Greenfield EMC is 310.70 acres.

6. The details of funding for the project approved by the Competent Authority under the Electronics Manufacturing Clusters Scheme are as provided in the table hereunder. The TSIC or the SPV (*as the case be*) undertakes to ensure the contribution from Cluster enterprises/ units to the tune of ₹ 109.25 crore.

(₹ in crore)

| # | Funding Sources | Amount |
|---|---------------------------------------|---------------|
| 1 | Grant-in-aid from Government of India | 172.40 |
| 2 | Contribution from Chief Promoter | 155.35 |
| 3 | Contribution from constituent units | 109.25 |
| | Total | 437.00 |

g

7. Implementation schedule: The project components wise implementation schedule for the Project approved by the Competent Authority under the Electronics Manufacturing Clusters Scheme is as provided hereunder. The TSIC or the SPV (*as the case be*) undertakes to implement the Project within the approved timelines. In the event of considerable and persistent delay of the project, Govt. of India has the right to foreclose the Project, appoint a new implementation agency for execution of the Project and recover the entire Grant-in-aid released along with interest and penalties as stipulated in this approval letter.

(a) Total duration of the project – 36 months

(b) Project Component-wise timeline:

| Particulars | Timelines |
|--|---|
| Approval from Gol | Within one month from the date of approval |
| SPV formation | constituted |
| DPR preparation | 2 months (1 st to 2 nd month) |
| Plan approvals from concerned authorities | 1 month (3 rd month) |
| Detailed working drawings | 1 month (4 th month) |
| Financial closure | 1 month (5 th month) |
| Construction of basic development, essential services and support services | 25 months (6 th month to 31 st month) |
| Tenders for supply & installation of manufacturing support equipment | 1 month (5 th month) |
| Supply & installation of manufacturing support equipment | 17 months (5 th to 21 st month) |
| Allotment of plots to units | 14 months (4 th to 17 th month) |
| Commencement of Phase I of commercial operations | 18 th month onwards |
| Commencement of Phase II of commercial operations | 36 th month onwards |
| Project Completion | 36 Months |

8. TSIC shall ensure that SPV is formed in full compliance of terms and conditions laid out in the 'Guidelines for constitution of Special Purpose Vehicle (SPV) for implementation of Electronics Manufacturing Clusters (EMCs)' dated 30th January 2014 and Electronics Manufacturing Cluster Scheme, the Guidelines and any other instructions issued by MeitY from time to time. In the event of failing to comply with the conditions laid out in EMC Scheme and/ or Guidelines including the utilization of land or committing breach of the bond at any time, the TSIC or the SPV (*as the case be*) shall be liable to refund to the President of India the entire amount of the Grant-in-aid with interest @ Prime Lending Rate (PLR) per annum prevailing at that time and as notified by Reserve Bank of India. The TSIC or the SPV (*as the case be*) will also be liable to such other penalties as provided under the approval and any other law. MeitY may also take legal action for recovery of the dues as may be considered appropriate.

9. The TSIIIC or the SPV (*as the case be*) shall execute a bond for proper utilization of grant wherein it shall undertake that it shall abide by the terms and conditions specified in the approval letter, the terms of the Scheme and Guidelines and any instruction issued by the Ministry of Electronics and Information Technology from time to time. The TSIIIC or the SPV (*as the case be*) shall also be required to provide a *Self-certified undertaking that they have not obtained or applied for grants for the same purpose or activity from any other Ministry or Department of the Government of India or State Government*. In the event of failing to comply with the conditions laid out in EMC Scheme and/ or Guidelines including the utilization of land or committing breach of the bond at any time, the TSIIIC or the SPV (*as the case be*) shall be liable to refund to the President of India the entire amount of the Grant-in-aid with interest @ Prime Lending Rate (PLR) per annum prevailing at that time and as notified by Reserve Bank of India and will be liable to such other penalties as provided under the approval and any other law. MeitY may also take legal action for recovery of the dues as may be considered appropriate.
10. The TSIIIC or the SPV (*as the case be*) shall create an Escrow account with a Nationalized Bank and shall provide the details thereof to the Ministry of Electronics and Information Technology (MeitY) Government of India. The Government of India shall enter into a Tripartite Agreement (TPA) with the TSIIIC or the SPV (*as the case be*) and the Bank where the escrow account of the TSIIIC or the SPV (*as the case be*) is maintained for proper utilization of the central grant. The terms of the escrow account shall be as approved by the Government of India.
11. The TSIIIC or the SPV (*as the case be*) shall ensure that minimum 80% of the land of the Electronic Manufacturing Cluster shall be allotted to processing area while remaining 20% of the land may be allotted for non-processing area. The TSIIIC or the SPV (*as the case be*) shall ensure that a minimum of 75% units within the EMC should be from among the verticals covered under Modified Special Incentives Package Scheme.
12. The Chief Promoter shall transfer the land for the project to the SPV. The Chief Promoter shall provide necessary undertaking in this regard.
13. The disbursement of Grant-in-aid shall be made on *pari passu* basis i.e. all proportionate payments to be released after the corresponding share to be mobilized by the TSIIIC or the SPV (*as the case be*) and is deposited in the escrow account and other necessary conditions for release of such payments as prescribed have been complied. The same is to be applicable on all the installments with effect from the first installment to be released to the applicant.
14. The applicant shall also undertake to abide by all recommended conditions regarding allotment of land as per EMC scheme, Guidelines and terms & conditions of approval. Failure to abide by any of the above will make liable for penalties as envisaged under the Policy/ Guidelines and any other law. Necessary undertaking in this regard shall be provided by the applicant.
15. In the event of any shortfall in project funds, or non-collection of the contributions from the constituent units in successful completion of the project, the same will have to be mobilized and brought in by Chief promoter M/s TSIIIC as per undertaking of M/s TSIIIC dated 24.03.2017.

16. The applicant shall ensure that the following 7 units who have confirmed their investment in the said EMC will make investment towards setting up of their electronic manufacturing facilities:

- i. M/s Accord Power Conversion Pvt. Ltd
- ii. M/s Kakatiya Energy Systems Pvt. Ltd.
- iii. M/s LEDISON LED Lighting Pvt. Ltd.
- iv. M/s Resolute Electronics Pvt. Ltd.
- v. M/s Filmore LED Pvt. Ltd.
- vi. M/s LED Chip Indus Pvt. Ltd.
- vii. M/s Kwaliti Photonics Pvt. Ltd. (Anchor unit)

17. The first installment of Grant-in-aid (i.e. 20% of the Grant-in-aid) will be released after compliance of other terms & conditions as mentioned in this approval letter and fulfilling of the below mentioned criteria's:

- a) Submission and execution of the requisite administrative legal documents viz; Bond, Memorandum of Agreement, Tripartite Agreement (TPA) etc. and after the deposition of the equivalent proportionate contribution in to the ESROW account.
- b) The applicant should obtain Environmental Clearance as per EIA notification and Consent to Establishment Certificate from State Pollution Control Board and submit a copy of the same to MeitY.

18. The second and subsequent installments shall be released (to be released to the SPV after execution of the Novation Agreement) as mentioned below:

- i. Second Installment i.e. 30% of the Grant-in-aid to be released on complying the following conditions:
 - a) The SPV should be constituted in compliance with the requirements of "Guidelines for constitution of Special Purpose Vehicle (SPV) for implementation of Electronics Manufacturing Clusters (EMCs) dated 30th January 2014."
 - b) There should be at least one representative of the concerned Government or its agency on the Board of Directors in the SPV.
 - c) Allotment of land to at least 5 constituent units (or at least 10% of land, whichever is higher).
 - d) After utilization of 80% of first installment and proportionate contribution from constituent units/ State Government/Chief Promoter.
- ii. Third Installment of Grant-in-aid (i.e. 30% of grant-in-aid) to be released on complying the following condition:
 - a) The structure of the SPV should comply with the Guidelines for constitution of "Special Purpose Vehicle (SPV) for implementation of Electronics Manufacturing Clusters (EMCs) dated 30th January, 2014".
 - b) Allotment of land to at least 7 constituent units (or at least 20% of land, whichever is higher)

- c) At least two constituent units should have started setting up of manufacturing facilities within EMC
 - d) Submission of all pending approvals viz. fire-fighting plan, clearance from Chief controller of Explosives, etc. from concerned authorities.
 - e) After utilization of 80% of second installment and proportionate contribution from constituent units/ State Government/Chief Promoter.
 - iii. Fourth installment i.e. 20% of Grant-in-aid will be released on complying the following conditions:
 - a) Allotment of at least 80% of the saleable land to constituent units.
 - b) The production should have commenced by at least first allottees of land.
 - c) Construction and setting up of manufacturing facility should have been started by at least 50% of the land allottees.
 - d) After utilization of 100 % of earlier installments and proportionate contribution from constituent units/ State Government/Chief Promoter
 - e) Successful completion of the project
19. The Government of India's disbursement will be effected to the escrow account only when proportionate contribution from the TSIIC or the SPV (*as the case be*) is deposited in the escrow account. All the payment to the TSIIC or the SPV (*as the case be*) will be released subject to and in accordance to clause 6.13 of the EMC Guidelines. The deposits in the escrow account shall be utilized only for authorized expenditure for the approved project. The Bank Guarantee mentioned in clause 6.13 of the EMC Guidelines shall be in a form acceptable to MeitY.
20. The TSIIC or the SPV (*as the case be*) shall provide status on quarterly basis to Project Monitoring Committee (PMC)/ MeitY on physical/ financial progress and the units being set up/ proposed to be set up in the EMC and ensure that at least 75% of the units should be engaged in Electronics System Design and Manufacturing (ESDM) as per M-SIPS Policy.
21. Any escalation in the approved project cost will have to be fully borne by the applicant.
22. TSIIC along with the SPV shall be responsible for timely execution of the project and proper utilization of the funds.
23. In the event of considerable and persistent delay of the project, MeitY has the right to foreclose the project, appoint a new implementation agency for execution of the project and recover the entire Grant-in-aid released along with penalties.
24. The Grant-in-aid sanctioned by the Government of India would be utilized only for the project components mentioned in this letter.

25. Any enhancement in the cost of the individual project components shall be solely borne by the TSIIIC or the SPV. The TSIIIC or the SPV (*as the case be*) shall arrange additional funds, if any required, to meet time and cost overruns. The Central grant for the purposes shall be limited to amount approved for Grant-in-aid as per this approval letter.
26. In the event of reduction of cost in a project component, the Central grant shall automatically get reduced on pro-rata basis for the said project component.
27. It shall be the responsibility of the TSIIIC or the SPV (*as the case be*) to obtain necessary approvals and clearances as applicable before implementation.
28. The TSIIIC or the SPV (*as the case be*) shall submit the "Utilization Certificate" on the basis of audit done by Chartered Accountant and after the acceptance of the same by its Board of Director.
29. The TSIIIC or the SPV (*as the case be*) shall maintain subsidiary accounts of the GOI grant and furnish to the Accounts Officer a set of audited statement of accounts. These audited statements of accounts should be furnished after utilization of Grant-in-aid or whenever called for.
30. The TSIIIC or the SPV (*as the case be*) shall undertake all procurement of goods, equipment and services or any other item through a transparent and competitive procurement process. Appropriate performance guarantees should be built in the agreement(s) to ensure timely and good quality delivery of goods and services procured.
31. In case MeitY, Government of India is of the opinion that the implementation of the project or operation of the SPV is not satisfactory or in case of disputes amongst the Board members of the SPV, the Government of India would have the powers to effect a change in the management of the SPV or issue such directions as may be necessary. The Articles of Association of the SPV shall be suitably formulated and if required modified to enable the Government of India to enforce, if required the above conditions stipulated while sanctioning the Grant-in-aid.
32. Any other special terms and conditions or procedures for transaction of business, as Government may desire to be followed by the SPV, shall be incorporated in the Articles of Association of the SPV before release of Grant-in-aid.
33. The SPV shall appoint a Managing Director or Chief Executive Officer with approval of its Board of Directors. However, the appointment shall need ratification by the Ministry of Electronics and Information Technology thereafter. SPV or the Managing Director of the SPV, as the case be, would be the Drawing and Disbursing Officer for the amounts released under this approval letter.
34. The TSIIIC or the SPV (*as the case be*) shall submit performance-cum-achievement report before applying for the next installment as grant (within 6 months from end of every Financial Year).

35. Accounts of the TSIIIC or the SPV (*as the case be*) shall be open to inspection by the Ministry of Electronics and Information Technology and audit, both by the Comptroller and Auditor General of India under the provision of CAG (DPC) Act 1971 and internal audit by the Principal Accounts Office of the Ministry of Communication and Information Technology or Ministry of Electronics and Information Technology, whenever the TSIIIC or the SPV (*as the case be*) is called upon to do so.
36. The TSIIIC or the SPV (*as the case be*) shall complete process for transfer of the roads and Right of Way as per proposal to Govt. of India for the Project.
37. The assets acquired wholly or substantially out of Government of India's Grant-in-aid shall not, without the prior sanction of the Government of India, be disposed of, encumbered or utilized for the purpose other than for which the Grant-in-aid has been released.
38. The TSIIIC or the SPV (*as the case be*) shall provide a certificate of actual utilization of the grants received for the purpose for which it was sanctioned in latest format prescribed in GFR or notified by Ministry of Finance on time to time as and when required by the Government of India. The Utilization Certificate should be submitted within six months of the closure of the financial year by the SPV. Receipt of such certificate shall be scrutinized by MeitY. Where such certificate is not received from the SPV within the prescribed time, the Ministry or Department will be at liberty to blacklist such Chief Promoter and/ or the SPV from any future grant, subsidy or other type of financial support from the Government.
39. The TSIIIC or the SPV (*as the case be*) shall maintain a register of permanent and semi-permanent assets acquired wholly or mainly out of the funds of Grant-in-aid on the basis of Form GFR -19.
40. The TSIIIC or the SPV (*as the case be*) shall furnish a return of such assets acquired during a financial year in the Form-GFR-19.
41. The SPV shall fix user charges for various facilities and services provided by under the Project in order to ensure that it fully recovers the O&M cost and make the Project sustainable.
42. In case of winding up, dissolution, etc. of the SPV, at any point in time, all assets and any unutilized grant shall automatically vest with the Government of India.
43. The TSIIIC or the SPV (*as the case be*) shall report on the physical progress as well as the expenditure incurred in the Project to the Nodal Officer of the EMC Scheme every quarter.
44. MeitY shall display on its website the details of the Project approved and the progress of its implementation.
45. Out of the Grant-in-aid, the administrative expenses (incurred during the execution of the Project) shall be limited to that approved as per this approval letter. Administrative expenses beyond this amount shall be met by the TSIIIC or the SPV (*as the case be*) from its own resources.

46. In the event of failing to comply with the conditions laid out in EMC Scheme and/ or Guidelines and/ or this approval letter (including the utilization of land) at any time, the TSIIIC or the SPV (*as the case be*) shall be liable to refund to the President of India the entire amount of the Grant-in-aid with interest @ Prime Lending Rate (PLR) per annum of RBI thereon and will be liable to such other penalties as provided under the approval and any other law. MeitY shall also be entitled to take legal action for recovery of the dues as may be considered appropriate.

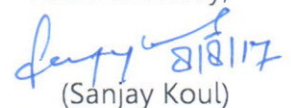
47. The TSIIIC or the SPV (*as the case be*) shall submit all relevant documents within the timelines as specified in the EMC Scheme and Guidelines, demonstrating the fulfillment of all terms and conditions precedent at each stage.

48. The contents of this approval letter shall prevail in case of any conflict with any previous communication from MeitY/ GOI in this regard.

49. The terms and conditions of this approval letter are in addition to the standard terms and conditions mentioned in Annexure – 8 of the EMC Guidelines. In case of any conflict between the terms and conditions mentioned in this approval letter and the terms and conditions mentioned in the EMC Scheme or EMC Guidelines or any other terms and conditions imposed on the SPV regarding the Project, Government of India shall have the sole authority and right to decide which terms and conditions shall prevail and the decision of the Government of India shall be final and binding on the SPV.

50. In case of any dispute, Secretary, Ministry of Electronics and Information Technology, Government of India, shall be the sole "Arbitrator" and his decision shall be final and binding for all concerned.

Yours faithfully,



(Sanjay Koul)

Principal Technical Officer
Tel: 011-24301781

Copy to:

1. PS to Hon'ble Minister(E&IT)for kind information of Hon'ble Minister(E&IT),Govt. of India
2. PS to Hon'ble MOS(E&IT) for kind information of Hon'ble MOS(E&IT), Govt. of India
3. Secretary, MeitY
4. AS&FA, MeitY
5. Secretary, Department of Industries, Government of Telangana



(Sanjay Koul)

Principal Technical Officer
Tel: 011-24301781

Definitions:

Capitalized terms used in the approval letter no. 36(6)/2014-IPHW(Vol.V) dated 8th August, 2017 issued to M/s Telangana State Industrial Infrastructure Corporation Ltd (TSIIC) shall have the meaning ascribed to such terms in the EMC Scheme and EMC Guidelines and where such terms are not defined therein, the terms shall have the meaning, unless the context otherwise requires, as provided below:

1. **Chief Promoter:** M/s Telangana State Industrial Infrastructure Corporation Ltd (TSIIC)
2. **Grant-in-aid:** Financial assistance provided by MeitY towards implementation of the project (refer para 4.1 of the EMC Scheme dated 22nd October, 2012).
3. **Project:** Project for setting up of Greenfield EMC at Maheshwaram, Ranga Reddy District, Telangana submitted by M/s Telangana State Industrial Infrastructure Corporation Ltd (TSIIC)
4. **MeitY:** Ministry of Electronics and Information Technology, Government of India.
5. **PLR:** Prime Lending Rate as issued by RBI prevailing at the time occurrence of the event.
6. **GOI:** Ministry of Electronics & Information Technology acting for and on behalf of the President of India
7. **Form GFR-19:** General Financial Rules (GFR) issued by Ministry of Finance, Government of India from time to time.
8. **EMC Scheme:** Electronic Manufacturing Scheme Notification No. 252 dated 22nd October, 2012 in Part-I, Section 1 of the Gazette of India (Extraordinary) [F.No. 8(50)/2011-IPHW]
9. **EMC Guidelines:** Guidelines for Electronics Manufacturing Clusters (EMC) Scheme to provide world class infrastructure for attracting investments in the Electronics Systems Design and Manufacturing (ESDM) Sector dated 15th April, 2013 [F.No. 8(50)/2011-IPHW].
10. **SPV Guidelines:** Notification of Guidelines for constitution of Special Purpose Vehicle (SPV) for implementation of Electronics Manufacturing Clusters (EMCs) dated 30th January, 2014 [F.No. 8(131)/2012-IPHW].
11. **Accounts Officer:** Accounts Officer appointed by Ministry of Electronics and Information Technology
12. **Utilization certificate:** Utilization Certificate stipulated as per format prescribed in GFR/ notified by Ministry of Finance on time to time.

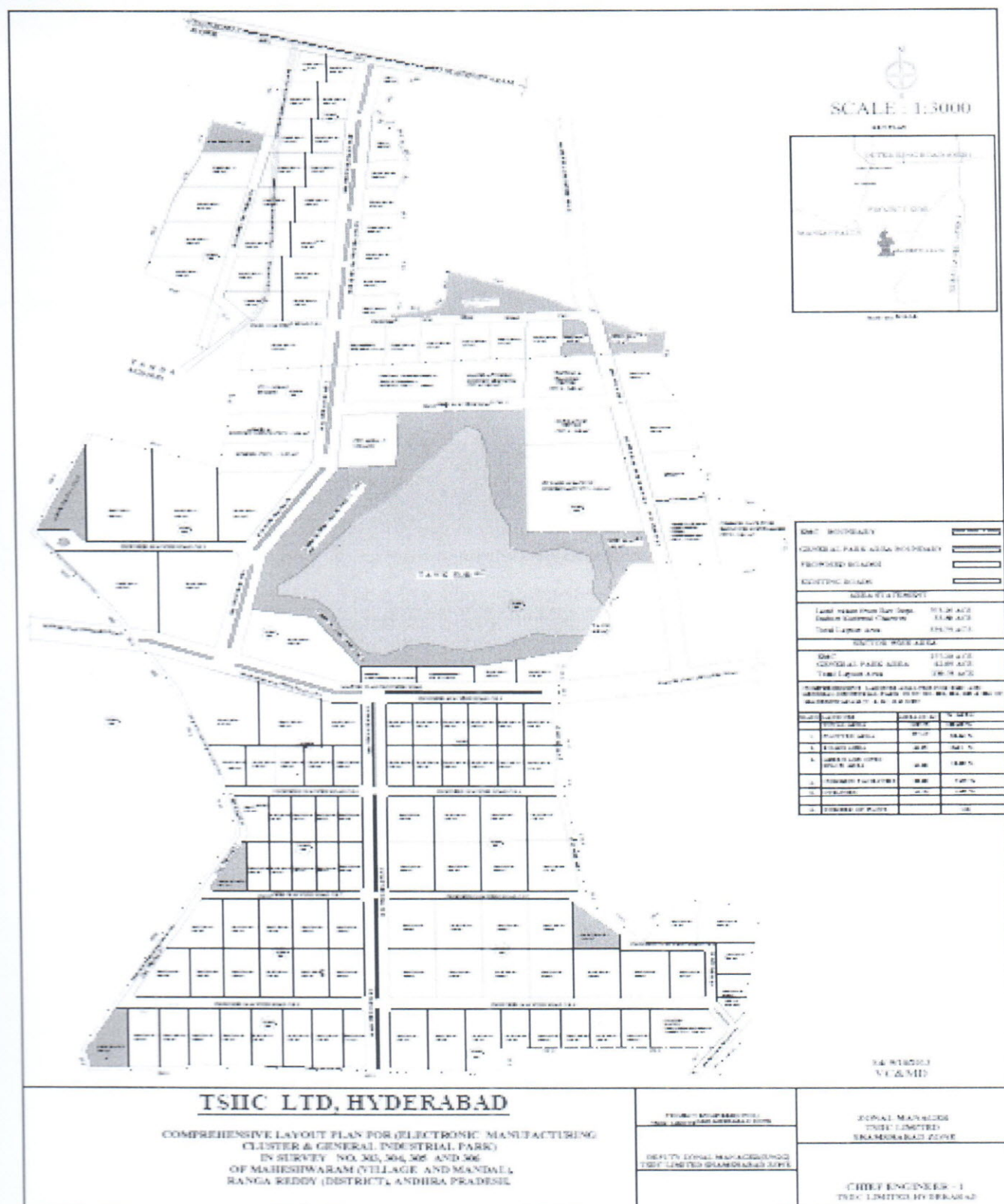
Annexure B

Site Connectivity and Layout of the Greenfield Electronics Manufacturing Cluster at Maheshwaram, Ranga Reddy District, Telangana



Site Connectivity: Latitude (17°07'35.10"N) and longitude (78°25'02.12"E)

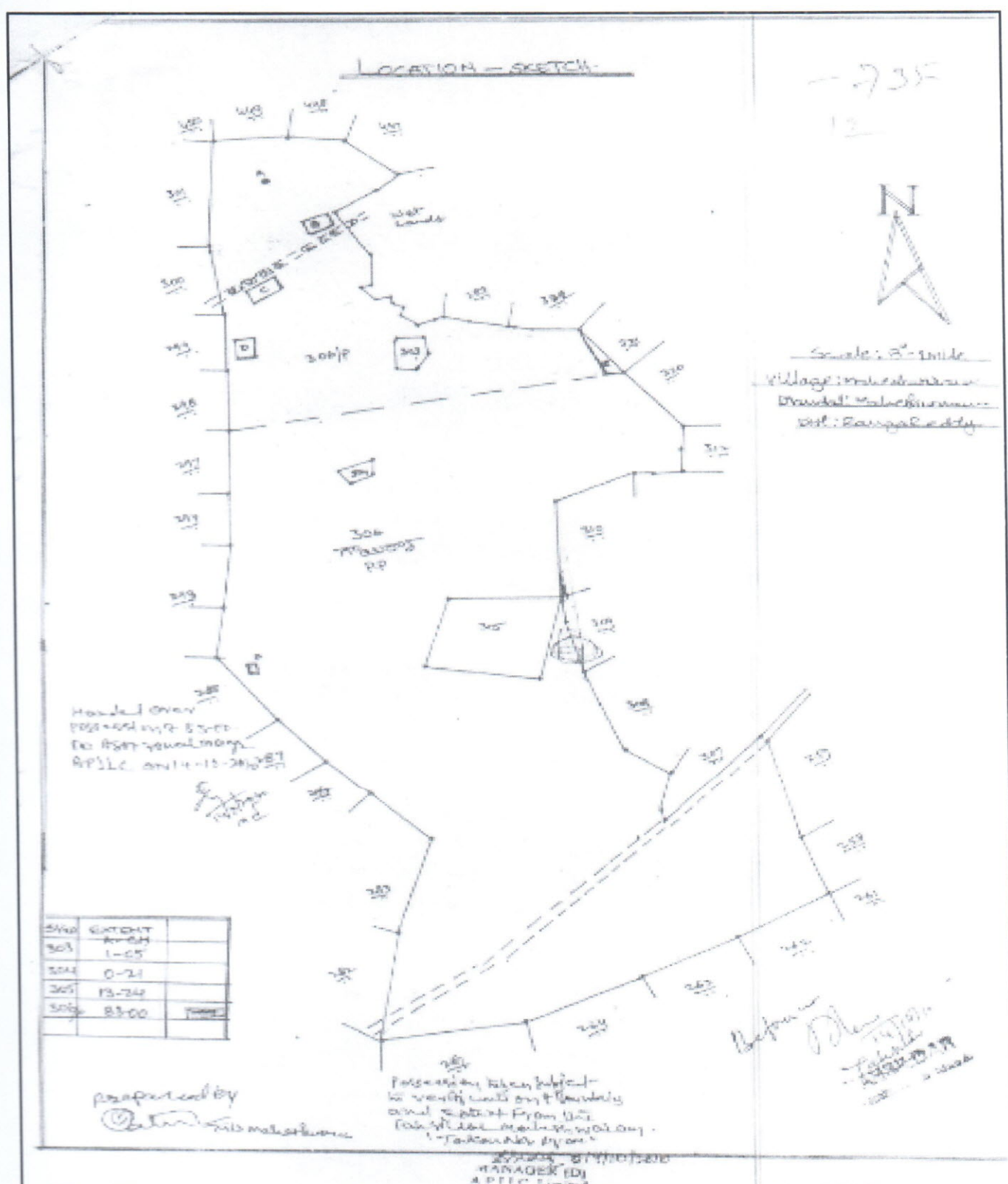


Layout of the Greenfield EMC at Maheshwaram, Ranga Reddy District, Telangana



Land documents showing survey no. of Greenfield Electronics Manufacturing Cluster at Maheshwaram, Ranga Reddy District, Telangana

| | |
|---|--|
|  Hyderabad Metropolitan Development Authority District Commercial Complex, Tarnaka, Hyderabad LAND USE INFORMATION Letter No: H2031-LU/PS/HMDA/2014 dt:14.07.2014 | |
| To The Zonal Manager, APHC Limited, Shamshabad Zone, Opp: RSFP&D, Srisailem Highway, Pahadi Shareef, via Keshavnagiri (Post), Hyderabad. | |
| Sir, Sub:-HMDA - Furnishing of Land Use Information. Ref:-Your application No.1794, dt:14.07.2014. | |
| With reference to your application cited, the details of Land Use Information as per statutory provisions of Metropolitan Development Plan-2031 for Hyderabad Metropolitan Region notified by the Govt. Vide G.O.Ms.No.33, MA dt.24.01.2013 is furnished hereunder(*): | |
| Survey No. | Land Use |
| 303 | : Manufacturing Use Zone. |
| 304 | : General Development Promotion Zone (GDPZ). |
| 305 | : Partly Manufacturing Use Zone, Partly Open Space Buffer Use Zone (Around Foreshore of Water Bodies), Partly Water Bodies (Cheruvu) and proposed 45 mtr wide road is passing through the Sy.No. |
| 306/1 | : Major Part Manufacturing Use Zone, Partly Two Village Settlements (1) Naguladana Tanda and (2) Kotwalcheruvu Tanda, Partly Residential Use Zone (R4), Partly Open Space Buffer Use Zone (Around Foreshore of Water Bodies), Partly Water Bodies (Cheruvu) and proposed Two (2) 45 mtr & Two 30 mtr wide roads are passing through the Sy.No. |
| VILLAGE | : MAHESHWARAM |
| MANDAL | : MAHESHWARAM |
| DISTRICT | : RANGA REDDY |
| NOTE: (1) This information does not bar any public agency or department including the HMDA from acquisition of Lands for Public purpose or from converting the Land Use at any time as per the Law. (2) This information shall not be used as the proof of any title to the Land. (3) This information shall not be used as the sole reason for obtaining exemption from the provisions of U.L.C.Act.1976. (4) This information does not provide any development permission under the APUA (Dev) Act.1975/HMDA Act, 2008. (5) Land use information does not guarantee that any Lay-Out or Building permission will be granted by competent authority. Any Building/Lay-Out permission will have to be examined and granted by competent authority based on Building/Lay-Out/Land use Rules and conditions. (6) This letter is solely for information purpose only. (7) The Land Use Certificate is given on the basis of cadastral data shown in MDP-2031. (8) The water bodies shall also be read as per revenue records. (*) The Land Use Certificate is given as per approval of M.C., in Note File No.11432/MDP/2013 dt:19.02.2014. | |
| Yours faithfully,  M. V. Srinivas Junior Planning Officer 18/7/14 | |



Scale: 3" = 1 mile

| Site | Extent | |
|------|--------|---------|
| 303 | 1-05 | |
| 304 | 0-21 | |
| 305 | 13-24 | |
| 306 | 83-00 | 7-10-00 |

prepared by
 (2) *Patricia* this molecule

Personality taken subject-
to verity until on Thursday
and extract from the
last three months waiting.
"Tackled from"

MANAGER (D)
A.P.L.C. 11-12

Before [Signature]
[Signature]
[Signature]
[Signature]

List of equipment under Manufacturing Support Services:

| Category Type | Category Name | S.No. | Description | Quantity | Total Cost in ₹ |
|------------------------|-----------------------------|-------|--|-------------|-----------------|
| A | Testing & Calibration | 1 | Testing Software & Application Development Platform | 4 | 1,23,12,000 |
| | | 2 | RFIC Signal Tester | 1 | 9,58,22,000 |
| Sub-Total (A) | | | | | 10,81,34,000 |
| B | Research & Development | 1 | EDA Design Suite | 1 | 68,40,000 |
| | | 2 | Test Software & Application Development Platform | 1 | 30,78,000 |
| Sub-Total (B) | | | | | 99,18,000 |
| C | CAD/CAM Design House | 1 | Auto works CAD Design & Simulation Tools | 1 | 17,10,000 |
| Sub-Total (C) | | | | | 17,10,000 |
| D | Plastic Molding & Packaging | 1 | THERMIONICS -THERMAL STREAM -80 DEG C TO + 225 DEG C MODEL | 1 | 47,88,000 |
| | | 2 | VACUUM SEALER | 1 | 13,68,000 |
| Sub-Total (D) | | | | | 61,56,000 |
| E | Support Works | 1 | ESD FLOORING | 1000 Sq.ft. | 6,84,000 |
| | | 2 | ESD TESTER | 1 | 34,20,000 |
| | | 3 | COMPRESSOR UNIT/PLUMBING | 1 | 47,88,000 |
| | | 4 | UPS BACK UP--200KVA | 1 | 23,94,000 |
| | | 5 | Miscellaneous | LS | 7,96,000 |
| Sub-Total (E) | | | | | 1,20,82,000 |
| Grand Total(A+B+C+D+E) | | | | | 13,80,00,000 |